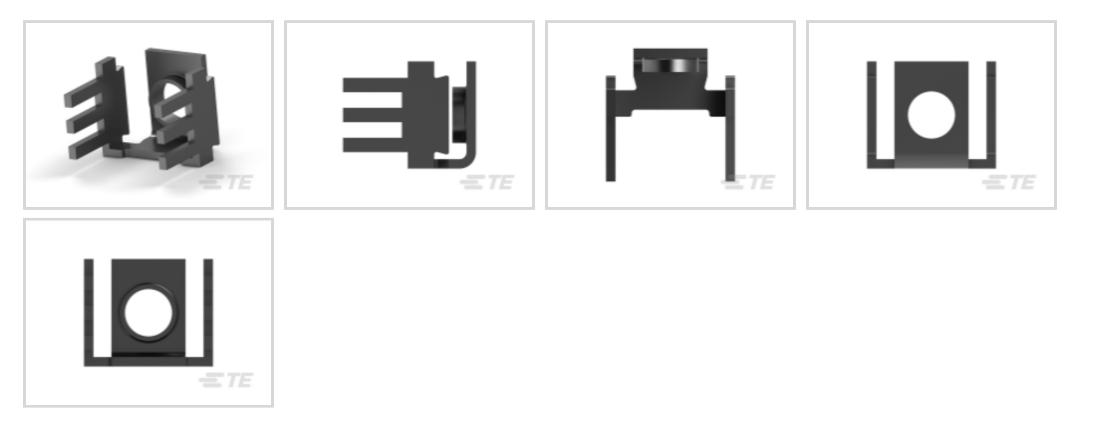
216907-1 ! PENDING OBSOLESCENCE

AMP POWER TAP

TE Internal #: 216907-1 TE Internal Description: .250 POWER TERM.A.P View on TE.com >



Terminals & Splices > Power Terminals



Power Terminal Type: Power Tap

Product Terminates To: **Printed Circuit Board**

Number of Positions: 6

Contact Current Rating (Max): 20 A

Centerline (Pitch): 10.16 mm [.4 in]

Features

Product Type Features

Power Terminal Type	Power Tap	
Configuration Features		
Number of Positions	6	
PCB Mount Orientation	Vertical	
Body Features		
Terminal Profile	Standard	
Contact Features		
Contact Current Rating (Max)	20 A	
Contact Fabrication	Stamped & Formed	
Contact Mating Area Plating Material	Tin	
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]	
PCB Contact Termination Area Plating Material	Tin	
PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]	
Contact Base Material	Phosphor Bronze	

Termination Features



Termination Method to Printed Circuit Board	Through Hole - Press-Fit	
Product Terminates To	Printed Circuit Board	
Mechanical Attachment		
Thread Size	M4	
Housing Features		
Centerline (Pitch)	10.16 mm[.4 in]	
Dimensions		
PCB Thickness (Recommended)	1.57 – 3.18 mm[.062 – .125 in]	
Product Length	10.96 mm[.431 in]	
Usage Conditions		
Insulation Option	Uninsulated	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]	
Packaging Features		
Packaging Method	Box	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant		
EU ELV Directive 2000/53/EC	Compliant		
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold		
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC		
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free		
older Process Capability Not applicable for solder process capab			
Product Compliance Disclaimer This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous			



materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought



€ TE	₹TE	TE TE	
TE Part #1676247-2	TE Part #1676344-2	TE Part #1676474-2	TE Part #YDTS26F17-08SNV001
RN 0805 200R 0.1% 10PPM 1KRL	RN 0805 453R 0.1% 10PPM 1KRL	RN 0805 9K53 0.1% 10PPM 1KRL	PLUG ASSY



Documents

Product Drawings .250 POWER TERM.A.P

& For support call+1 800 522 6752



English

CAD Files

Customer View Model

ENG_CVM_CVM_216907-1_B.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_216907-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_216907-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Datasheets & Catalog Pages POWER_CONNECTORS_CATALOG_SEC02_CABLE_MOUNTED

English

PRINTED CIRCUIT BOARD TERMINALS AND DISCONNECTS

English

Product Specifications Application Specification

English